



# SKLUU-X3

MIL-STD RUGGED CORE 17
FANLESS COMPUTER



- Extended Temp Support -40~+70 Degre
   e
- MIL-STD Vibration, Shock Tolerant
- Intel i7-7820EQ (4x Cores, 3.7Ghz)
- 9V~36V DC Input

## **Specifications**

#### SYSTEM

Core i7-7820EQ, 8M Cache (45W)
DDR4 Up to 32GB SO-DIMM
QM175 PCH
1 x Full-size mPCle/mSATA w/SIM card slot
1 x Half-size mPCle
1 x FPE connector
1 x StackPC connector
AMI® UEFI BIOS
2, Max resolution up to 3840 x 2160
1, Max resolution up to 2048 x 1536
Dual channel 24bit LVDS
512 GB
1 x Intel I210-IT & 1 x I 219-LM GbE
Yes
1
4P Rugged Terminal connector
2 x USB 3.0
Power, HDD, LAN (Link/Active/Speed)
2
1
2 x RJ45
1 x RS232/422/485 with 5V/12V selectable

USB Port	2 x USB 3.0
Audio	1 x MIC, 1 x Line out
APPLICATIONS, O	PERATING SYSTEM
Applications	Commercial and Military Platforms Requiring Compliance to MIL-STD-810G Embedded Computing, Process Control, Intelligent Automation and
	manufactur-ing applications where Harsh Temperature, Shock, Vibration, Altitude, Dust and EMI Conditions.  Used in all aspects of the military.
Operating System	Win 7 32/64Bit, Win 8 32/64Bit, Win 8.1 32/64Bit, Win 10 32/64Bit Ubuntu13.04, Ubuntu13.10, Ubuntu14.04, Fedora 20
PHYSICAL	
Dimension (W x D x H)	250 x 149 x 76mm
Weight	3.6 Kg (7.94 lbs)
Chassis	Aluminum Alloy, Corrosion Resistant
Finish	Anodic aluminum oxide (Color Iron gray)
Cooling	Natural Passive Convection/Conduction. No Moving Parts.
Ingress Protection	Dust Proof (Similar to IP50)

#### **ENVIRONMENTAL**

MIL-STD-810G	Method 507.5, Procedure II (Temperature & Humidity)
	Method 516.6 Shock-Procedure V Non-Operating (Mechanical
	Shock)
	Method 516.6 Shock-Procedure I Operating (Mechanical Shock)
	Method 514.6 Vibration Category 24/Non-Operating (Category 20 &
	24, Vibration) Method 514.6 Vibration Category 20/Operating
	(Category 20 & 24, Vibration) Method 501.5, Procedure I
	(Storage/High Temperature)
	Method 501.5, Procedure II (Operation/High Temperature)
	Method 502.5, Procedure I (Storage/Low Temperature)
	Method 502.5, Procedure II (Operation/Low Temperature)
	Method 503.5, Procedure I (Temperature shock)
Reliability	No Moving Parts; Passive Cooling.
	Designed & Manufactured using ISO 9001/2000 Certified Quality Program.
EMC	CE and FCC compliance
Green Product	RoHS, WEEE compliance

## **Ordering Information**

SR100-X3

MIL-STD-810G Rugged Computer with Intel® Core $^{\rm m}$  i7- 7820EQ, 9V to 36V DC-in, Mini PCIe, Extended Temp. -40~70°C

### Dimension

